

MC74AC74, MC74ACT74

Dual D-Type Positive Edge-Triggered Flip-Flop

The MC74AC74/74ACT74 is a dual D-type flip-flop with Asynchronous Clear and Set inputs and complementary (Q, \bar{Q}) outputs. Information at the input is transferred to the outputs on the positive edge of the clock pulse. Clock triggering occurs at a voltage level of the clock pulse and is not directly related to the transition time of the positive-going pulse. After the Clock Pulse input threshold voltage has been passed, the Data input is locked out and information present will not be transferred to the outputs until the next rising edge of the Clock Pulse input.

Asynchronous Inputs:

LOW input to \bar{S}_D (Set) sets Q to HIGH level

LOW input to \bar{C}_D (Clear) sets Q to LOW level

Clear and Set are independent of clock

Simultaneous LOW on \bar{C}_D and \bar{S}_D makes both Q and \bar{Q} HIGH

Features

- Outputs Source/Sink 24 mA
- 'ACT74 Has TTL Compatible Inputs
- These are Pb-Free Devices

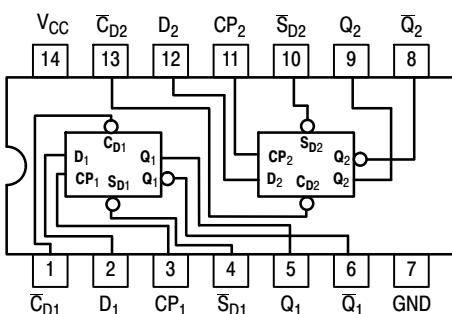


Figure 1. Pinout: 14-Lead Packages Conductors
(Top View)

PIN ASSIGNMENT

PIN	FUNCTION
D_1, D_2	Data Inputs
CP_1, CP_2	Clock Pulse Inputs
$\bar{C}_{D1}, \bar{C}_{D2}$	Direct Clear Inputs
$\bar{S}_{D1}, \bar{S}_{D2}$	Direct Set Inputs
$Q_1, \bar{Q}_1, Q_2, \bar{Q}_2$	Outputs



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MARKING DIAGRAMS



xxx = AC or ACT
A = Assembly Location
WL or L = Wafer Lot
Y = Year
WW or W = Work Week
G or ▪ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

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TRUTH TABLE (Each Half)

Inputs			Outputs	
\bar{S}_D	\bar{C}_D	CP	Q	\bar{Q}
L	H	X	X	H
H	L	X	X	L
L	L	X	X	H
H	H	—	H	H
H	H	—	L	L
H	H	L	X	Q_0
				\bar{Q}_0

NOTE: H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial;

— = LOW-to-HIGH Clock Transition

$Q_0(\bar{Q}_0)$ = Previous Q(\bar{Q}) before LOW-to-HIGH Transition of Clock

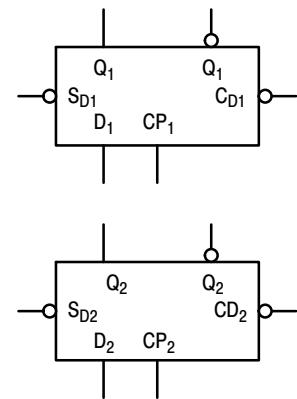
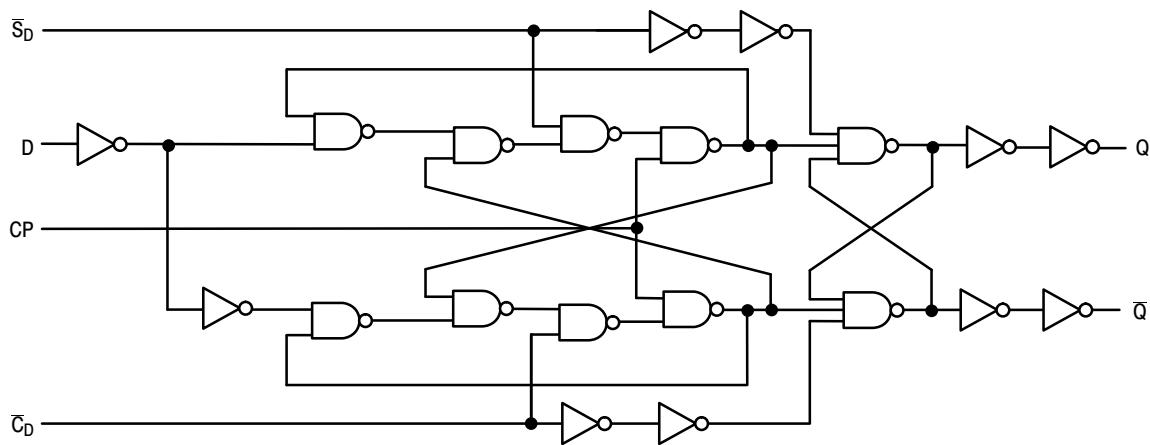


Figure 2. Logic Symbol



NOTE: This diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Figure 3. Logic Diagram

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MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage	−0.5 to +7.0	V
V_I	DC Input Voltage	$-0.5 \leq V_I \leq V_{CC} + 0.5$	V
V_O	DC Output Voltage (Note 1)	$-0.5 \leq V_O \leq V_{CC} + 0.5$	V
I_{IK}	DC Input Diode Current	±20	mA
I_{OK}	DC Output Diode Current	±50	mA
I_O	DC Output Sink/Source Current	±50	mA
I_{CC}	DC Supply Current per Output Pin	±50	mA
I_{GND}	DC Ground Current per Output Pin	±50	mA
T_{STG}	Storage Temperature Range	−65 to +150	°C
T_L	Lead temperature, 1 mm from Case for 10 Seconds	260	°C
T_J	Junction temperature under Bias	+150	°C
θ_{JA}	Thermal Resistance (Note 2)	SOIC TSSOP 125 170	°C/W
P_D	Power Dissipation in Still Air at 85°C	SOIC TSSOP 125 170	mW
MSL	Moisture Sensitivity	Level 1	
F_R	Flammability Rating	Oxygen Index: 30% – 35%	UL 94 V-0 @ 0.125 in
V_{ESD}	ESD Withstand Voltage	Human Body Model (Note 3) Machine Model (Note 4) Charged Device Model (Note 5)	> 2000 > 200 > 1000
$I_{Latch-Up}$	Latch-Up Performance Above V_{CC} and Below GND at 85°C (Note 6)	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. I_O absolute maximum rating must be observed.
2. The package thermal impedance is calculated in accordance with JESD51-7.
3. Tested to EIA/JESD22-A114-A.
4. Tested to EIA/JESD22-A115-A.
5. Tested to JESD22-C101-A.
6. Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Max	Unit
V_{CC}	Supply Voltage	'AC	2.0	5.0	6.0
		'ACT	4.5	5.0	5.5
V_{in}, V_{out}	DC Input Voltage, Output Voltage (Ref. to GND)	0	–	V_{CC}	V
t_r, t_f	Input Rise and Fall Time (Note) 'AC Devices except Schmitt Inputs	$V_{CC} @ 3.0 \text{ V}$	–	150	–
		$V_{CC} @ 4.5 \text{ V}$	–	40	–
		$V_{CC} @ 5.5 \text{ V}$	–	25	–
t_r, t_f	Input Rise and Fall Time (Note) 'ACT Devices except Schmitt Inputs	$V_{CC} @ 4.5 \text{ V}$	–	10	–
		$V_{CC} @ 5.5 \text{ V}$	–	8.0	–
T_J	Junction Temperature (PDIP)	–	–	140	°C
T_A	Operating Ambient Temperature Range	−40	25	85	°C
I_{OH}	Output Current – High	–	–	−24	mA
I_{OL}	Output Current – Low	–	–	24	mA

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. V_{in} from 30% to 70% V_{CC} ; see individual Data Sheets for devices that differ from the typical input rise and fall times.
2. V_{in} from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

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DC CHARACTERISTICS

Symbol	Parameter	V _{CC} (V)	74AC		74AC	Unit	Conditions
			T _A = +25°C		T _A = -40°C to +85°C		
			Typ	Guaranteed Limits			
V _{IH}	Minimum High Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	2.1 3.15 3.85	2.1 3.15 3.85	V	V _{OUT} = 0.1 V or V _{CC} - 0.1 V
V _{IL}	Maximum Low Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	0.9 1.35 1.65	0.9 1.35 1.65	V	V _{OUT} = 0.1 V or V _{CC} - 0.1 V
V _{OH}	Minimum High Level Output Voltage	3.0 4.5 5.5	2.99 4.49 5.49	2.9 4.4 5.4	2.9 4.4 5.4	V	I _{OUT} = -50 μA
		3.0 4.5 5.5	— — —	2.56 3.86 4.86	2.46 3.76 4.76	V	*V _{IN} = V _{IL} or V _{IH} I _{OH} -12 mA -24 mA -24 mA
V _{OL}	Maximum Low Level Output Voltage	3.0 4.5 5.5	0.002 0.001 0.001	0.1 0.1 0.1	0.1 0.1 0.1	V	I _{OUT} = 50 μA
		3.0 4.5 5.5	— — —	0.36 0.36 0.36	0.44 0.44 0.44	V	*V _{IN} = V _{IL} or V _{IH} I _{OL} 12 mA 24 mA 24 mA
I _{IN}	Maximum Input Leakage Current	5.5	—	±0.1	±1.0	μA	V _I = V _{CC} , GND
I _{OLD}	†Minimum Dynamic Output Current	5.5	—	—	75	mA	V _{OLD} = 1.65 V Max
I _{OHD}		5.5	—	—	-75	mA	V _{OHD} = 3.85 V Min
I _{CC}	Maximum Quiescent Supply Current	5.5	—	4.0	40	μA	V _{IN} = V _{CC} or GND

*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}.

AC CHARACTERISTICS

Symbol	Parameter	V _{CC} (V)	74AC			74AC	Unit	Fig. No.
			T _A = +25°C C _L = 50 pF			T _A = -40°C to +85°C C _L = 50 pF		
			Min	Typ	Max	Min		
f _{max}	Maximum Clock Frequency	3.3 5.0	100 140	125 160	— —	95 125	— —	MHz 3-3
t _{PLH}	Propagation Delay C _{Dn} or S _{Dn} to Q _n or Q̄ _n	3.3 5.0	5.0 3.5	8.0 6.0	12.5 9.0	4.0 3.0	13.0 10.0	ns 3-6
t _{PHL}	Propagation Delay C _{Dn} or S _{Dn} to Q̄ _n or Q _n	3.3 5.0	4.0 3.0	10.5 8.0	12.0 9.5	3.5 2.5	13.5 10.5	ns 3-6
t _{PLH}	Propagation Delay C _{Pn} to Q _n or Q̄ _n	3.3 5.0	4.5 3.5	8.0 6.0	13.5 10.0	4.0 3.0	16.0 10.5	ns 3-6
t _{PHL}	Propagation Delay C _{Pn} to Q _n or Q̄ _n	3.3 5.0	3.5 2.5	8.0 6.0	14.0 10.0	3.5 2.5	14.5 10.5	ns 3-6

*Voltage Range 3.3 V is 3.3 V ±0.3 V.

Voltage Range 5.0 V is 5.0 V ±0.5 V.

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AC OPERATING REQUIREMENTS

Symbol	Parameter	V _{CC} * (V)	74AC		74AC	Unit	Fig. No.
			T _A = +25°C C _L = 50 pF		T _A = -40°C to +85°C C _L = 50 pF		
			Typ	Guaranteed Minimum			
t _s	Set-up Time, HIGH or LOW D _n to CP _n	3.3 5.0	1.5 1.0	4.0 3.0	4.5 3.0	ns	3-9
t _h	Hold Time, HIGH or LOW D _n to CP _n	3.3 5.0	-2.0 -1.5	0.5 0.5	0.5 0.5	ns	3-9
t _w	C _{Pn} or \bar{C}_{Dn} or \bar{S}_{Dn} Pulse Width	3.3 5.0	3.0 2.5	5.5 4.5	7.0 5.0	ns	3-6
t _{rec}	Recovery Time \bar{C}_{Dn} or \bar{S}_{Dn} to CP	3.3 5.0	-2.5 -2.0	0 0	0 0	ns	3-9

*Voltage Range 3.3 V is 3.3 V \pm 0.3 V.

Voltage Range 5.0 V is 5.0 V \pm 0.5 V.

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DC CHARACTERISTICS

Symbol	Parameter	V _{CC} (V)	74ACT		74ACT		Unit	Conditions		
			T _A = +25°C		T _A = -40°C to +85°C					
			Typ	Guaranteed Limits						
V _{IH}	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	2.0 2.0	V	V _{OUT} = 0.1 V or V _{CC} - 0.1 V		
V _{IL}	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	0.8 0.8	V	V _{OUT} = 0.1 V or V _{CC} - 0.1 V		
V _{OH}	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	4.4 5.4	V	I _{OUT} = -50 μA		
		4.5 5.5	— —	3.86 4.86	3.76 4.76	3.76 4.76	V	*V _{IN} = V _{IL} or V _{IH} I _{OH} -24 mA -24 mA		
V _{OL}	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	0.1 0.1	V	I _{OUT} = 50 μA		
		4.5 5.5	— —	0.36 0.36	0.44 0.44	0.44 0.44	V	*V _{IN} = V _{IL} or V _{IH} I _{OL} 24 mA 24 mA		
I _{IN}	Maximum Input Leakage Current	5.5	—	±0.1	±1.0	±1.0	μA	V _I = V _{CC} , GND		
ΔI _{CCT}	Additional Max. I _{CC} /Input	5.5	0.6	—	1.5	1.5	mA	V _I = V _{CC} - 2.1 V		
I _{OLD}	†Minimum Dynamic Output Current	5.5	—	—	75	75	mA	V _{OLD} = 1.65 V Max		
I _{OHD}		5.5	—	—	-75	-75	mA	V _{OHD} = 3.85 V Min		
I _{CC}	Maximum Quiescent Supply Current	5.5	—	4.0	40	40	μA	V _{IN} = V _{CC} or GND		

*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

AC CHARACTERISTICS

Symbol	Parameter	V _{CC} * (V)	74ACT			74ACT		Unit	Fig. No.		
			T _A = +25°C C _L = 50 pF			T _A = -40°C to +85°C C _L = 50 pF					
			Min	Typ	Max	Min	Max				
f _{max}	Maximum Clock Frequency	5.0	145	210	—	125	—	MHz	3-3		
t _{PLH}	Propagation Delay \bar{C}_{Dn} or \bar{S}_{Dn} to Q _n or \bar{Q}_n	5.0	3.0	5.5	9.5	2.5	10.5	ns	3-6		
t _{PHL}	Propagation Delay \bar{C}_{Dn} or \bar{S}_{Dn} to Q _n or \bar{Q}_n	5.0	3.0	6.0	10.0	3.0	11.5	ns	3-6		
t _{PLH}	Propagation Delay C _{Pn} to Q _n or \bar{Q}_n	5.0	4.0	7.5	11.0	4.0	13.0	ns	3-6		
t _{PHL}	Propagation Delay C _{Pn} to Q _n or \bar{Q}_n	5.0	3.5	6.0	10.0	3.0	11.5	ns	3-6		

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

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AC OPERATING REQUIREMENTS

Symbol	Parameter	V _{CC} * (V)	74ACT		74ACT	Unit	Fig. No.	
			T _A = +25°C C _L = 50 pF		T _A = -40°C to +85°C C _L = 50 pF			
			Typ	Guaranteed Minimum				
t _s	Set-up Time, HIGH or LOW D _n to CP _n	5.0	1.0	3.0		3.5	ns	3-9
t _h	Hold Time, HIGH or LOW D _n to CP _n	5.0	-0.5	1.0		1.0	ns	3-9
t _w	C _{PN} or \bar{C}_{Dn} or \bar{S}_{Dn} Pulse Width	5.0	3.0	5.0		6.0	ns	3-6
t _{rec}	Recovery Time \bar{C}_{Dn} or \bar{S}_{Dn} to CP	5.0	-2.5	0		0	ns	3-9

*Voltage Range 5.0 V is 5.0 V \pm 0.5 V.

CAPACITANCE

Symbol	Parameter	Value Typ	Unit	Test Conditions
C _{IN}	Input Capacitance	4.5	pF	V _{CC} = 5.0 V
C _{PD}	Power Dissipation Capacitance	35	pF	V _{CC} = 5.0 V

ORDERING INFORMATION

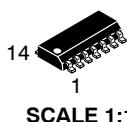
Device	Package	Shipping [†]
MC74AC74DG	SOIC-14 (Pb-Free)	55 Units/Rail
MC74AC74DR2G	SOIC-14 (Pb-Free)	2500/Tape & Reel
MC74AC74DTR2G	TSSOP-14 (Pb-Free)	2500/Tape & Reel
MC74ACT74DG	SOIC-14 (Pb-Free)	55 Units/Rail
MC74ACT74DR2G	SOIC-14 (Pb-Free)	2500/Tape & Reel
MC74ACT74DTR2G	TSSOP-14 (Pb-Free)	2500/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

ON Semiconductor®



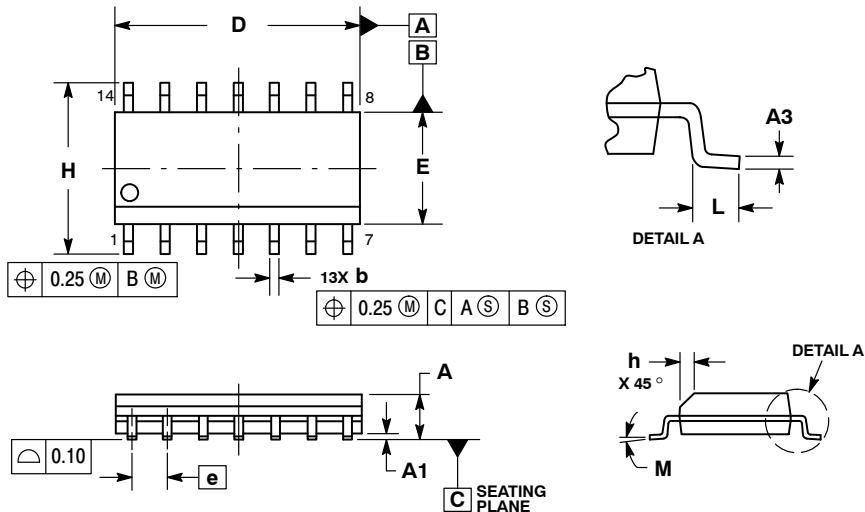
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SOIC-14 NB
CASE 751A-03
ISSUE L

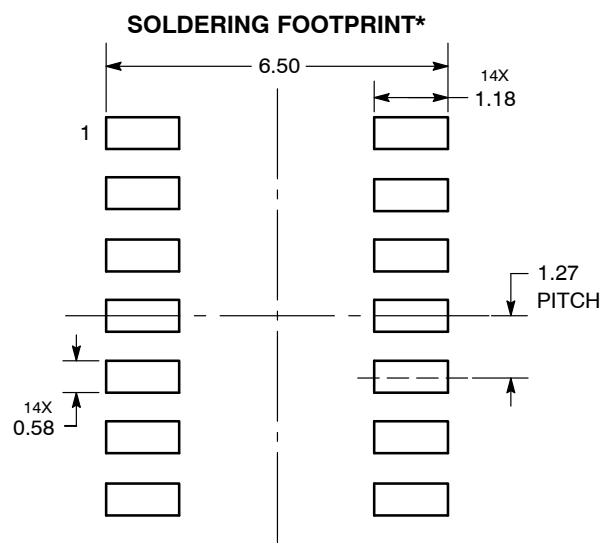
DATE 03 FEB 2016



NOTES:

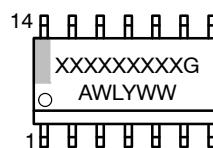
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF AT MAXIMUM MATERIAL CONDITION.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.
5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.054	0.068
A1	0.10	0.25	0.004	0.010
A3	0.19	0.25	0.008	0.010
b	0.35	0.49	0.014	0.019
D	8.55	8.75	0.337	0.344
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.019
L	0.40	1.25	0.016	0.049
M	0 °	7 °	0 °	7 °



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code
A = Assembly Location
WL = Wafer Lot
Y = Year
WW = Work Week
G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present.

STYLES ON PAGE 2

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SOIC-14
CASE 751A-03
ISSUE L

DATE 03 FEB 2016

STYLE 1:
PIN 1. COMMON CATHODE
2. ANODE/CATHODE
3. ANODE/CATHODE
4. NO CONNECTION
5. ANODE/CATHODE
6. NO CONNECTION
7. ANODE/CATHODE
8. ANODE/CATHODE
9. ANODE/CATHODE
10. NO CONNECTION
11. ANODE/CATHODE
12. ANODE/CATHODE
13. NO CONNECTION
14. COMMON ANODE

STYLE 2:
CANCELLED

STYLE 3:
PIN 1. NO CONNECTION
2. ANODE
3. ANODE
4. NO CONNECTION
5. ANODE
6. NO CONNECTION
7. ANODE
8. ANODE
9. ANODE
10. NO CONNECTION
11. ANODE
12. ANODE
13. NO CONNECTION
14. COMMON CATHODE

STYLE 4:
PIN 1. NO CONNECTION
2. CATHODE
3. CATHODE
4. NO CONNECTION
5. CATHODE
6. NO CONNECTION
7. CATHODE
8. CATHODE
9. CATHODE
10. NO CONNECTION
11. CATHODE
12. CATHODE
13. NO CONNECTION
14. COMMON ANODE

STYLE 5:
PIN 1. COMMON CATHODE
2. ANODE/CATHODE
3. ANODE/CATHODE
4. ANODE/CATHODE
5. ANODE/CATHODE
6. NO CONNECTION
7. COMMON ANODE
8. COMMON CATHODE
9. ANODE/CATHODE
10. ANODE/CATHODE
11. ANODE/CATHODE
12. ANODE/CATHODE
13. NO CONNECTION
14. COMMON ANODE

STYLE 6:
PIN 1. CATHODE
2. CATHODE
3. CATHODE
4. CATHODE
5. CATHODE
6. CATHODE
7. CATHODE
8. ANODE
9. ANODE
10. ANODE
11. ANODE
12. ANODE
13. ANODE
14. ANODE

STYLE 7:
PIN 1. ANODE/CATHODE
2. COMMON ANODE
3. COMMON CATHODE
4. ANODE/CATHODE
5. ANODE/CATHODE
6. ANODE/CATHODE
7. ANODE/CATHODE
8. ANODE/CATHODE
9. ANODE/CATHODE
10. ANODE/CATHODE
11. COMMON CATHODE
12. COMMON ANODE
13. ANODE/CATHODE
14. ANODE/CATHODE

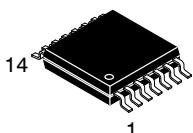
STYLE 8:
PIN 1. COMMON CATHODE
2. ANODE/CATHODE
3. ANODE/CATHODE
4. NO CONNECTION
5. ANODE/CATHODE
6. ANODE/CATHODE
7. COMMON ANODE
8. COMMON ANODE
9. ANODE/CATHODE
10. ANODE/CATHODE
11. NO CONNECTION
12. ANODE/CATHODE
13. ANODE/CATHODE
14. COMMON CATHODE

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MECHANICAL CASE OUTLINE

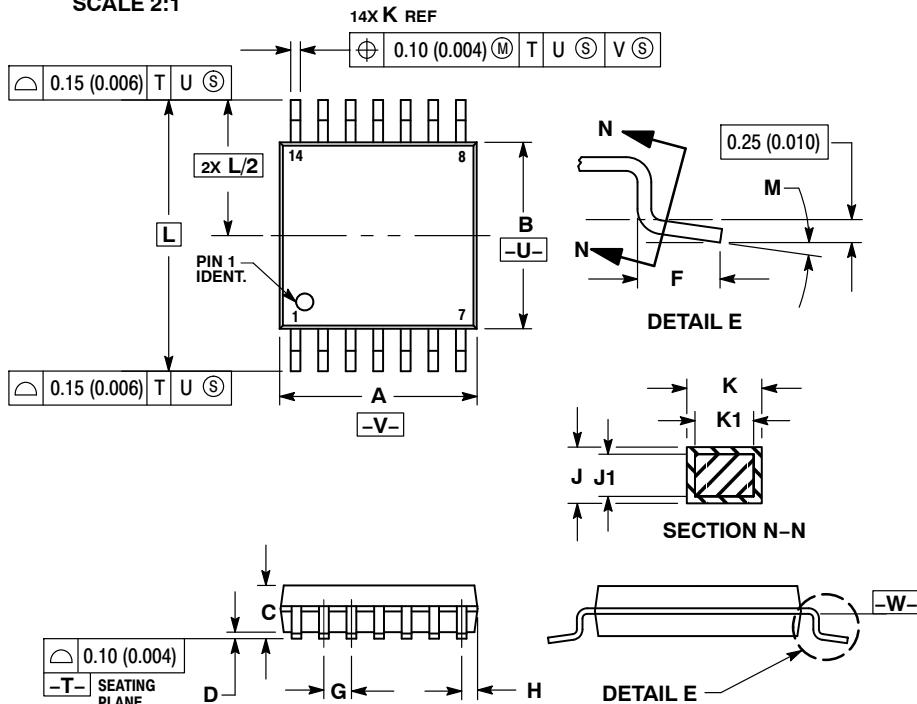
PACKAGE DIMENSIONS



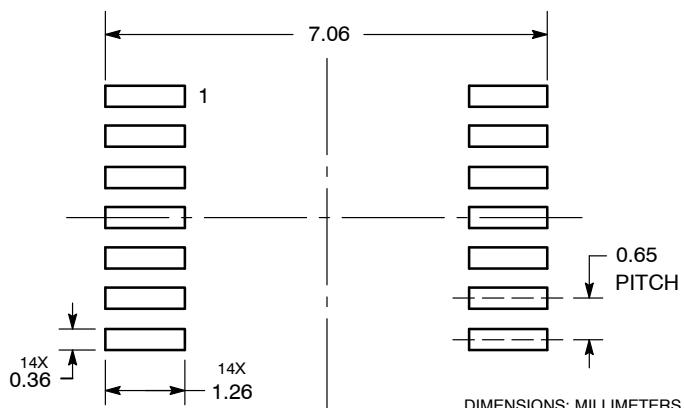
TSSOP-14 WB
CASE 948G
ISSUE C

DATE 17 FEB 2016

SCALE 2:1

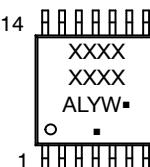


SOLDERING FOOTPRINT



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	----	1.20	----	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65	BSC	0.026	BSC
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40	BSC	0.252	BSC
M	0°	8°	0°	8°

GENERIC MARKING DIAGRAM*



A = Assembly Location
 L = Wafer Lot
 Y = Year
 W = Work Week
 □ = Pb-Free Package

(Note: Microdot may be in either location)
This information is generic. Please refer to device data sheet for actual part marking.
Pb-Free indicator, "G" or microdot "■", may or may not be present.

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